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## LIST OF REFERENCES CITED BY APPLICANT

(Use several sheets if necessary)

## APPLICANT

Peter C. EKLUND et al.

## FILING DATE

March 15, 2004

## GROUP ART UNIT

1773

## U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB-CLASS	FILING DATE
	AA						
	AB						
	AC						

## FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB-CLASS	TRANSLATION YES NO PART.
	AD						
	AE						

## OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, Etc.)

	AF	JANßen, S. et al., "Hydrogen Diffusion in Nanocrystalline Pd by Means of Quasielastic Neutron Scattering", 1997, <i>NanoStructured Materials</i> , Vol. 9, pages 579 - 582
JS	AG	KUJI, Toshiro et al., "Thermodynamic Properties of Hydrogen in Fine Pd Powders", 1999, <i>Journal of Alloys and Compounds</i> 293-295, pages 19 - 22
JS	AH	KUJI, Toshiro et al., "Hydrogen Absorption of Nanocrystalline Palladium", 2002, <i>Journal of Alloys and Compounds</i> 330-332, pages 718 - 722
JS	AI	NISHIMIYA, Nobuyuki et al., "Hyperstoichiometric Hydrogen Occlusion by Palladium Nanoparticles Included in NaY Zeolite", 2001, <i>Journal of Alloys and Compounds</i> 319, pages 312 - 321
JS	AJ	YAMAURA, Shin-ichi et al., "Hydrogen Absorption of Nanoscale Pd Particles Embedded in ZrO <sub>2</sub> Matrix Prepared from Zr-Pd Amorphous Alloys", June 2002, <i>J. Mater Res.</i> , Vol. 17, No. 6, pages 1329 - 1334
JS	AK	ZALUSKA, A. et al., "Structure, Catalysis and Atomic Reactions on the Nano-scale: A Systematic Approach to Metal Hydrides for Hydrogen Storage", 2001, <i>Applied Physics A Materials Science &amp; Processing</i> 72, pages 157 - 165

EXAMINER	/Jason Savage/	DATE CONSIDERED	10/13/2006
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\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.